Presence Condition of the Restricted Substances

Western Digital Products As of January 8, 2024

設備名稱:Memo Equipment Name	ry Cards	型號(型式): Memory Cards Type Designation (Type)					
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols						
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)	
Printed Circuit Board 電路板	0	0	0	0	0	0	
Connector 連接器	0	0	0	0	0	0	
Product Cover 外殼	0	0	0	0	0	0	
PCB Assembly 印刷電路板總成	_	0	0	0	0	0	

備考1. "超出0.1 wt %"及"超出0.01 wt %"係指限用物質之百分比含量超出百分比含量基準 Note 1: "Exceeding 0.1 wt %" and "exceeding 0.01 wt %" indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition

備考2. "○" 係指該項限用物質之百分比含量未超出百分比含量基準值

Note 2: " \circ " indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence

備考3. "一"係指該項限用物質為排除項目。

Note 3: The "-" indicates that the restricted substance corresponds to the exemption.

備考4:印刷电路板中铅只适用于欧盟豁免项目7(c)-I中的产品

Note 4: Lead in PCB Assembly applicable only to products that uses EU ROHS exemption 7(c)-I

Presence Condition of the Restricted Substances

Western Digital Products As of January 8, 2024

設備名稱:SSD Models Equipment Name		型號(型式):All type of SSD Models Type Designation (Type): Including USB/Other PCBA based products					
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols						
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)	
Printed Circuit Board 電路板	0	0	0	0	0	0	
Connector 連接器	0	0	0	0	0	0	
Product Cover 外殼	0	0	0	0	0	0	
PCB Assembly 印刷電路板總成	_	0	0	0	0	0	

備考1. "超出0.1 wt %"及 "超出0.01 wt %"係指限用物質之百分比含量超出百分比含量基準 Note 1: "Exceeding 0.1 wt %" and "exceeding 0.01 wt %" indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition

備考2. "○" 係指該項限用物質之百分比含量未超出百分比含量基準值

Note 2: " \circ " indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence

備考3. "一"係指該項限用物質為排除項目。

Note 3: The "-" indicates that the restricted substance corresponds to the exemption.

Presence Condition of the Restricted Substances

Western Digital Products As of January 8, 2024

設備名稱:Hard Drive Equipment Name		型號(型式): All type of HDD Models Type Designation (Type): Including System & Platform Products						
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols							
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)		
Base Motor Assembly 馬達基底總成	ı	0	0	0	0	0		
Top Cover 硬碟上蓋	0	0	0	0	0	0		
Disk 碟片	0	0	0	0	0	0		
PCB Assembly 印刷電路板總成	-	0	0	0	0	0		

備考1. "超出0.1 wt %"及 "超出0.01 wt %"係指限用物質之百分比含量超出百分比含量基準 Note 1: "Exceeding 0.1 wt %" and "exceeding 0.01 wt %" indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition

備考2. "○" 係指該項限用物質之百分比含量未超出百分比含量基準值

Note 2: "o" indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence

備考3. "一"係指該項限用物質為排除項目。

Note 3: The "-" indicates that the restricted substance corresponds to the exemption.

備考4. 馬達基底總成中的鉛使用,僅適用於使用歐盟ROHS 豁免項目6(a)-I的產品

Note 4: Lead in Base Motor Assembly applicable only to products that uses EU ROHS exemption 6(a)-I

Presence Condition of the Restricted Substances

Western Digital Products As of January 8, 2024

設備名稱:Platfor Equipment Name	m	型號(型式):All type of DCS products Type designation (Type)					
-	限用物質及其化學符號 Restricted substances and its chemical symbols						
單元Unit	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)	
Chassis outer shell & lens 機箱外皮殼與鏡片	0	0	0	0	0	0	
Plastic other parts 塑料其它部件	0	0	0	0	0	0	
Combination cable/power supply 組合電纜線/電源	0	0	0	0	0	0	
SSD/Hard Drive/Circuit board combination 固態硬碟/ 硬碟/電路板組合	_	0	0	0	0	0	

備考1. "超出0.1 wt %"及"超出0.01 wt %"係指限用物質之百分比含量超出百分比含量基準 Note 1: "Exceeding 0.1 wt %" and "exceeding 0.01 wt %" indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition

備考2. "○" 係指該項限用物質之百分比含量未超出百分比含量基準值

Note 2: " \circ " indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence

備考3."一"係指該項限用物質為排除項目。

Note 3: The "-" indicates that the restricted substance corresponds to the exemption.

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Taiwan BSMI RoHS

Presence Condition of the Restricted Substances

Western Digital Products As of January 8, 2024

設備名稱:CS Equipment Name	型號(型式): All type of CS products							
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols							
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)		
Chassis outer shell & lens 機箱外皮殼與鏡 片	0	0	0	0	0	0		
Plastic other parts 塑料其它部件	0	0	0	0	0	0		
Rubber Mats, 4 pieces 橡皮脚墊, 4片	0	0	0	0	0	0		
Sheet Metal parts 片金属部件	ı	0	0	0	0	0		
Combination cable/power supply 組合電纜線/電 源	I	0	0	0	0	0		
SSD/Hard Drive/Circuit board combination 固態硬碟/ 硬碟/電路板組 合	ı	0	0	0	0	0		

Western Digital.

Taiwan BSMI RoHS

Presence Condition of the Restricted Substances

備考1. "超出0.1 wt %"及 "超出0.01 wt %" 係指限用物質之百分比含量超出百分比含量基準 Note 1: "Exceeding 0.1 wt %" and "exceeding 0.01 wt %" indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition

備考2. "○" 係指該項限用物質之百分比含量未超出百分比含量基準值

Note 2: "o" indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence

備考3. "一"係指該項限用物質為排除項目。

Note 3: The "-" indicates that the restricted substance corresponds to the exemption.